

20 V, 1 A low VF MEGA Schottky barrier rectifier 4 August 2015 Pro

Product data sheet

### 1. General description

Planar Maximum Efficiency General Application (MEGA) Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a leadless ultra small DFN1006D-2 (SOD882D) Surface-Mounted Device (SMD) plastic package with visible and solderable side pads.

### 2. Features and benefits

- Average forward current: I<sub>F(AV)</sub> ≤ 1 A
- Reverse voltage: V<sub>R</sub> ≤ 20 V
- Low forward voltage  $V_F \le 490 \text{ mV}$
- AEC-Q101 qualified
- Ultra small and leadless SMD plastic package
- Solderable side pads
- Package height typ. 0.37 mm

### 3. Applications

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch mode power supply
- Reverse polarity protection
- Low power consumption applications
- Ultra high-speed switching
- LED backlight for mobile application

### 4. Quick reference data

Table 1. Quick reference data							
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I <sub>F(AV)</sub> average forwa current	average forward current	δ = 0.5 ; f = 20 kHz; T <sub>sp</sub> ≤ 130 °C; square wave		-	-	1	A
		δ = 0.5 ; f = 20 kHz; T <sub>amb</sub> ≤ 80 °C; square wave	[1]	-	-	1	A
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C		-	-	20	V
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 1 A; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02 ; T <sub>j</sub> = 25 °C		-	428	490	mV
I <sub>R</sub>	reverse current	V <sub>R</sub> = 10 V; T <sub>j</sub> = 25 °C		-	28	50	μA

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Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
t <sub>rr</sub>	reverse recovery time	$I_F = 0.5 \text{ A}; I_R = 0.5 \text{ A}; I_{R(meas)} = 0.1 \text{ A};$	-	1.6	-	ns
		T <sub>j</sub> = 25 °C				

[1] Device mounted on a ceramic PCB,  $AI_2O_3$ , standard footprint.

# 5. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	к	cathode[1]		1 🛃 2
2	А	anode		sym001
			Transparent top view	
			DFN1006D-2 (SOD882D)	

[1] The marking bar indicates the cathode.

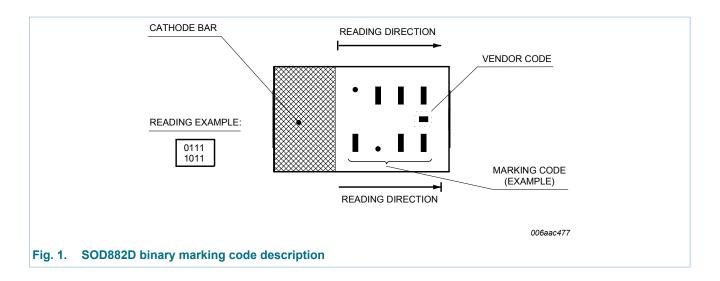
### 6. Ordering information

Table 3. Ordering information							
Type number	Package						
	Name	Description	Version				
PMEG2010BELD	DFN1006D-2	DFN1006D-2: leadless ultra small plastic package; 2 terminals	SOD882D				

### 7. Marking

Table 4. Marking codes	
Type number	Marking code
PMEG2010BELD	0000 1001

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### 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Мах	Unit
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C		-	20	V
l <sub>F</sub>	forward current	T <sub>sp</sub> ≤ 130 °C		-	1	А
I <sub>F(AV)</sub>	average forward current	δ = 0.5 ; f = 20 kHz; T <sub>sp</sub> ≤ 130 °C; square wave		-	1	A
		$\delta$ = 0.5 ; f = 20 kHz; T <sub>amb</sub> ≤ 80 °C; square wave	[1]	-	1	A
I <sub>FRM</sub>	repetitive peak forward current	t <sub>p</sub> ≤ 1 ms; δ ≤ 0.25		-	3	А
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 8 ms; $T_{j(init)}$ = 25 °C; square wave		-	6	A
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[2][3]	-	370	mW
			[4][3]	-	735	mW
			[1][3]	-	1135	mW
Tj	junction temperature			-	150	°C
T <sub>amb</sub>	ambient temperature			-55	150	°C
T <sub>stg</sub>	storage temperature			-65	150	°C

[1] Device mounted on a ceramic PCB,  $AI_2O_3$ , standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Reflow soldering is the only recommended soldering method.

 [4] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

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#### 9. Thermal characteristics

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Table 6. Thermal characteristics								
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit	
f	thermal resistance	in free air	[1][2][3]	-	-	340	K/W	
	from junction to ambient		[1][4][3] -	-	-	170	K/W	
			[1][5][3]	-	-	110	K/W	
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		<u>[6]</u>	-	-	25	K/W	

[1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses  $P_R$  are a significant part of the total power losses.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Reflow soldering is the only recommended soldering method.

- <sup>[4]</sup> Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [5] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.
- [6] Soldering point of cathode tab.

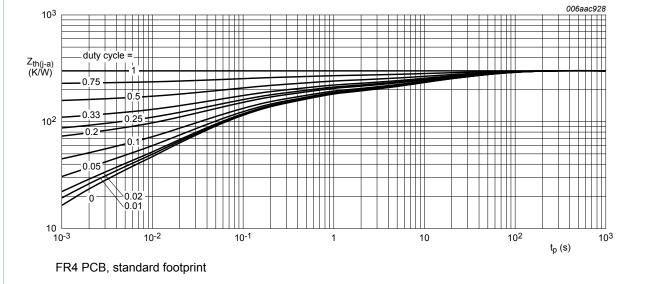
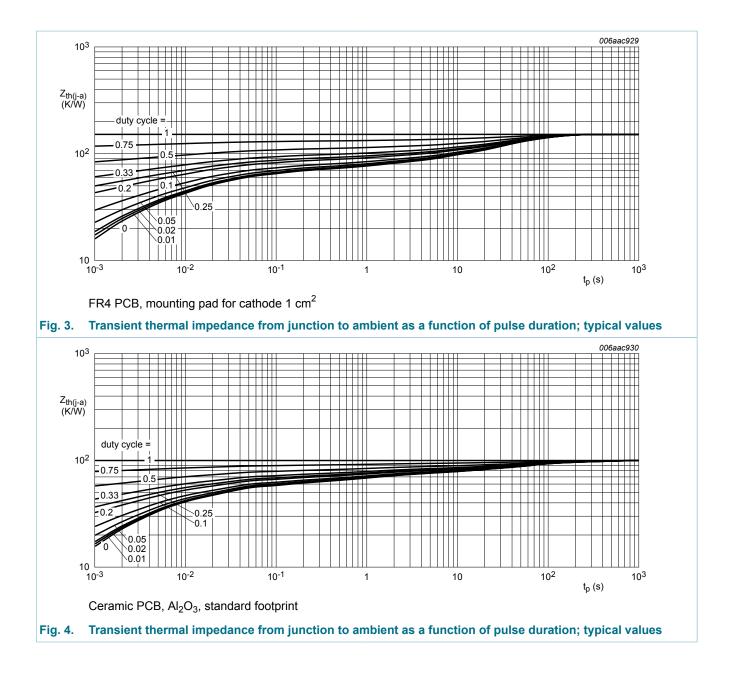


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

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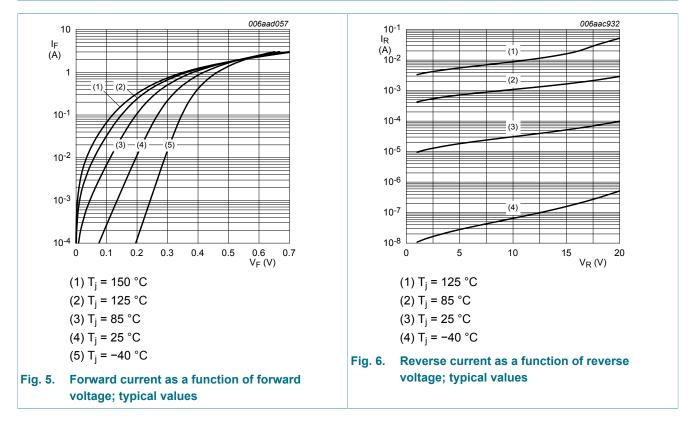
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### **10. Characteristics**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 100 mA; pulsed; t <sub>p</sub> ≤ 300 μs; $\delta \le 0.02$ ; T <sub>j</sub> = 25 °C	-	266	310	mV
		$I_F$ = 500 mA; pulsed; $t_p$ ≤ 300 μs; δ ≤ 0.02 ; $T_j$ = 25 °C	-	353	390	mV
		I <sub>F</sub> = 1 A; pulsed; t <sub>p</sub> ≤ 300 μs; $\delta$ ≤ 0.02 ; T <sub>j</sub> = 25 °C	-	428	490	mV
I <sub>R</sub>	reverse current	V <sub>R</sub> = 10 V; T <sub>j</sub> = 25 °C	-	28	50	μA
		V <sub>R</sub> = 20 V; T <sub>j</sub> = 25 °C	-	87	200	μA
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 1 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	31	40	pF
t <sub>rr</sub>	reverse recovery time	$I_{\rm F}$ = 0.5 A; $I_{\rm R}$ = 0.5 A; $I_{\rm R(meas)}$ = 0.1 A; $T_{\rm j}$ = 25 °C	-	1.6	-	ns
V <sub>FRM</sub>	peak forward recovery voltage	$I_F = 0.5 \text{ A}; \text{ d}I_F/\text{d}t = 20 \text{ A}/\mu\text{s}; \text{ T}_j = 25 ^\circ\text{C}$	-	565	-	mV

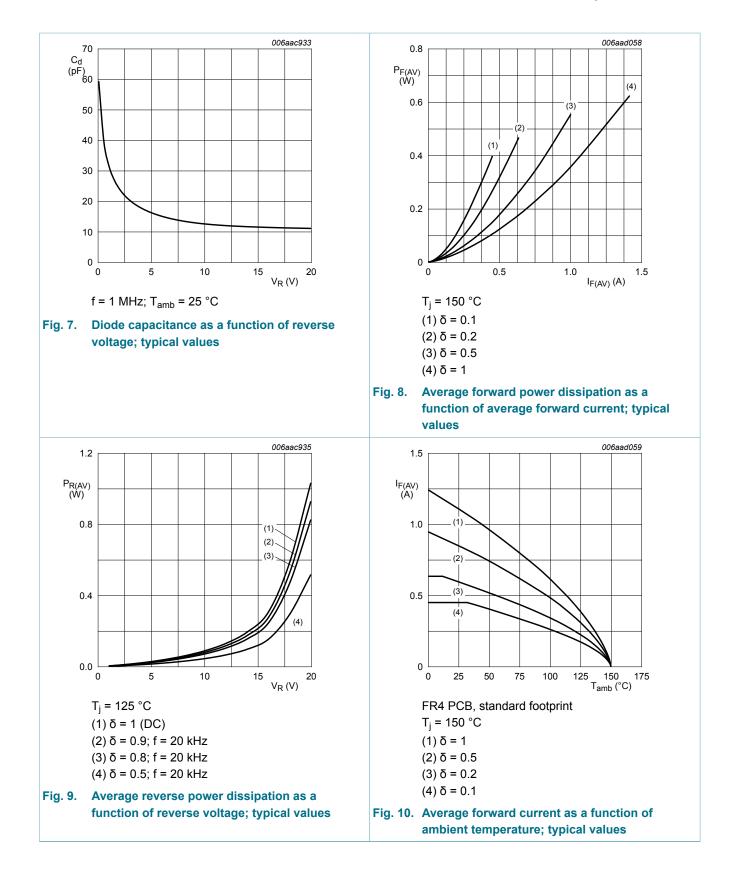


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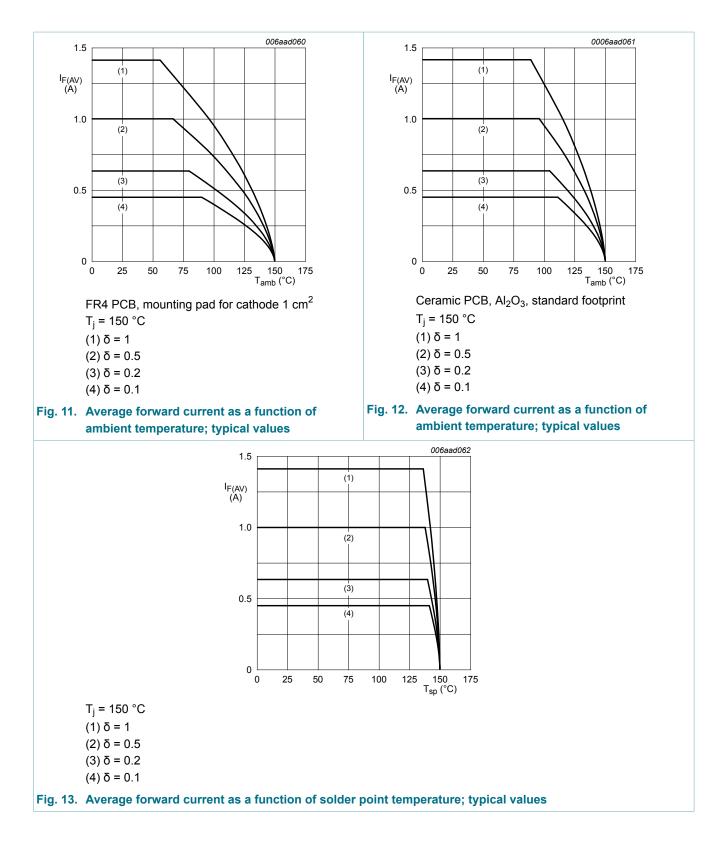
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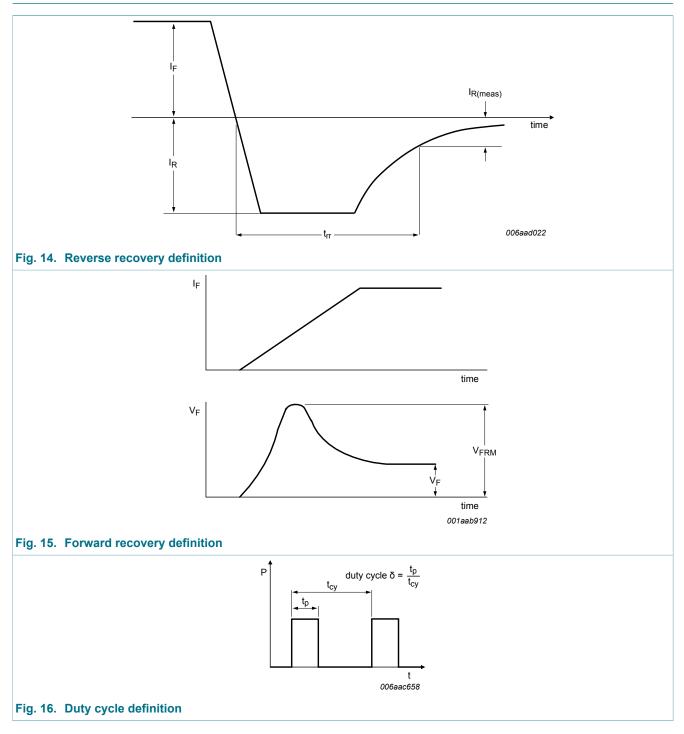
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## **11. Test information**



The current ratings for the typical waveforms are calculated according to the equations:  $I_{F(AV)} = I_M \times \delta$  with  $I_M$  defined as peak current,  $I_{RMS} = I_{F(AV)}$  at DC, and  $I_{RMS} = I_M \times \sqrt{\delta}$  with  $I_{RMS}$  defined as RMS current.

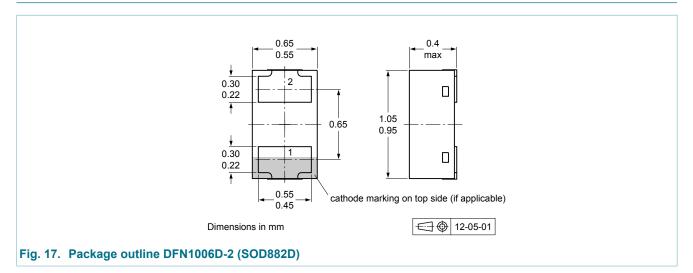
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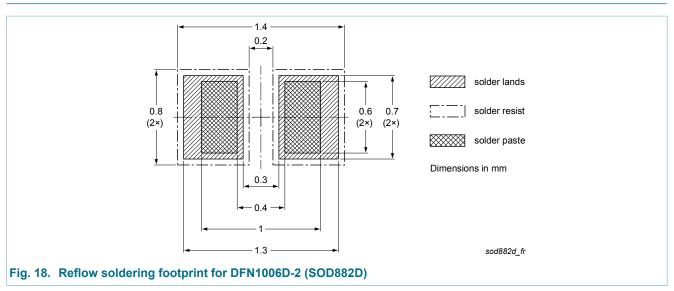
#### **11.1 Quality information**

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

### 12. Package outline



### 13. Soldering



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# 14. Revision history

Table 8.   Revision history							
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes			
PMEG2010BELD v.2	20150804	Product data sheet	-	PMEG2010BELD v.1			
Modifications:	Section Marking: updated figure 1.						
PMEG2010BELD v.1	20120418	Product data sheet	-	-			

#### 20 V, 1 A low VF MEGA Schottky barrier rectifier

#### **15. Legal information**

#### 15.1 Data sheet status

Document status [1][2]	Product status [ <u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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